

STY60NA20

PRELIMINARY DATA

N - CHANNEL 200V - 0.030Ω - 60 A - Max247 FAST POWER MOS TRANSISTOR

TYPE	V _{DSS}	R _{DS(on)}	ID
STY60NA20	200 V	< 0.032 Ω	60 A

- TYPICAL $R_{DS(on)} = 0.030 \Omega$
- EFFICIENT AND RELIABLE MOUNTING THROUGH CLIP
- \pm 30V GATE TO SOURCE VOLTAGE RATING
- REPETITIVE AVALANCHE TESTED
- LOW INTRINSIC CAPACITANCE
- 100% AVALANCHE TESTED
- GATE CHARGE MINIMIZED
- REDUCED THRESHOLD VOLTAGE SPREAD

DESCRIPTION

The Max247TM package is a new high volume power package exibiting the same footprint as the industry standard TO-247, but designed to accomodate much larger silicon chips, normally supplied in bigger packages such as TO-264. The increased die capacity makes the device ideal to reduce component count in multiple paralleled designs and save board space with respect to larger packages.

APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- SWITCH MODE POWER SUPPLIES (SMPS)
- DC-AC CONVERTERS FOR WELDING EQUIPMENT AND UNINTERRUPTIBLE POWER SUPPLIES (UPS)

ABSOLUTE MAXIMUM RATINGS

Max247TM

S(3) SC06140

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source Voltage (V _{GS} = 0)	200	V
V _{DGR}	Drain- gate Voltage ($R_{GS} = 20 \text{ k}\Omega$)	200	V
V _{GS}	Gate-source Voltage	± 30	V
ID	Drain Current (continuous) at T _c = 25 °C	60	A
Ι _D	Drain Current (continuous) at T _c = 100 °C	40	A
I _{DM} (●)	Drain Current (pulsed)	240	A
P _{tot}	Total Dissipation at $T_c = 25 \ ^{\circ}C$	300	W
	Derating Factor	2.4	W/°C
T _{stg}	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

(•) Pulse width limited by safe operating area

August 1998

THERMAL DATA

AVALANCHE CHARACTERISTICS

Symbol	Parameter	Max Value	Unit
I _{AR}	Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T_j max)	60	A
Eas	Single Pulse Avalanche Energy (starting $T_j = 25 \ ^{\circ}C$, $I_D = I_{AR}$, $V_{DD} = 50 \ V$)	3000	mJ

ELECTRICAL CHARACTERISTICS ($T_{case} = 25 \,^{\circ}C$ unless otherwise specified) OFF

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown Voltage	$I_D = 250 \ \mu A$	$V_{GS} = 0$	200			V
I _{DSS}	Zero Gate Voltage Drain Current (V _{GS} = 0)	V _{DS} = Max Rating V _{DS} = Max Rating	T _c = 100 ^o C			1 10	μΑ μΑ
lgss	Gate-body Leakage Current (V _{DS} = 0)	$V_{GS} = \pm 30 V$				± 100	nA

ON (*)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$ $I_D = 250 \ \mu A$	2	3	4	V
R _{DS(on)}	Static Drain-source On Resistance	$V_{GS} = 10 V I_D = 30A$		0.03	0.032	Ω
I _{D(on)}	On State Drain Current	$V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $V_{GS} = 10 V$	60			A

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g _{fs} (*)	Forward Transconductance	$V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $I_{D} = 30 \text{ A}$	20			S
Ciss Coss Crss	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 25 V$ f = 1 MHz $V_{GS} = 0$		6000 1400 500	8000 1900 700	pF pF pF



ELECTRICAL CHARACTERISTICS (continued)

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Turn-on Time Rise Time			40 50	55 70	ns ns
Qg Qgs Qgd	Total Gate Charge Gate-Source Charge Gate-Drain Charge	$V_{DD} = 160 \text{ V}$ $I_D = 60 \text{ A}$ $V_{GS} = 10 \text{ V}$		285 40 150	370	nC nC nC

SWITCHING OFF

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
tf	Off-voltage Rise Time Fall Time Cross-over Time	$V_{DD} = 160 V$ $R_G = 4.7 \Omega$	I _D = 60 A V _{GS} = 10 V		70 40 110	100 55 150	ns ns ns

SOURCE DRAIN DIODE

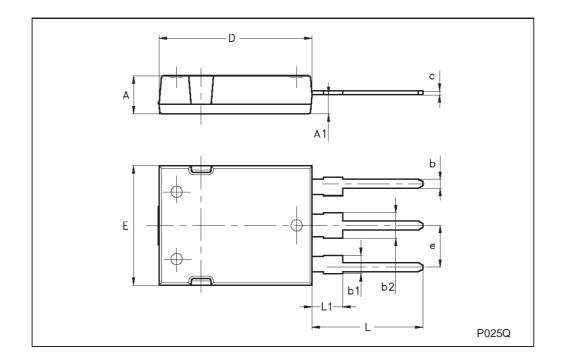
Symbol	Parameter	Test Cor	nditions	Min.	Тур.	Max.	Unit
I _{SD} I _{SDM} (●)	Source-drain Current Source-drain Current (pulsed)					60 240	A A
V _{SD} (*)	Forward On Voltage	I _{SD} = 60 A	$V_{GS} = 0$			1.5	V
t _{rr}	Reverse Recovery Time	I _{SD} = 60 A V _{DD} = 50 V	di/dt = 100 A/µs T _i = 150 ^o C		480		ns
Qrr	Reverse Recovery		.,		7.5		μC
	Charge						
I _{RRM}	Reverse Recovery Current				30		A

(*) Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %
(•) Pulse width limited by safe operating area

57

DIM.		mm		inch			
Dim.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX	
А	4.70		5.30				
A1	2.20		2.60				
b	1.00		1.40				
b1	2.00		2.40				
b2	3.00		3.40				
С	0.40		0.80				
D	19.70		20.30				
е	5.35		5.55				
E	15.30		15.90				
L	14.20		15.20				
L1	3.70		4.30		İ		

Max247 MECHANICAL DATA



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57